

Report from Technical Requirements Ad Hoc

IEEE 802.16 Presentation Submission Template (Rev. 8.3)

Document Number:

IEEE C802.16j-06/087r1

Date Submitted: 2006-07-20

Source:

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Venue:

Session #44 San Diego

Purpose:

Report Results from Ad Hoc meeting to harmonize technical requirements contributions.

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Technical Requirements Ad Hoc Meeting

Jerry Sydir (Ad Hoc Chair)

Ad Hoc Participants (1)

Masahito Asa – Motorola

David Steer – Nortel

Hyung Jgon Jeon – Posdata

Eckhard Bogenfeld – DT

Yeongha Choi – Solid Technologies

Terry Lingren – KTRC

Henry Chang – KTRC

Andrei Petrov – Conexant

Shyamal Ramachandran – Motorola

Young-il Kim – ETRI

Seungkwon Cho – ETRI

Byung-Jae Kwak – ETRI

Fang-Ching Ren – ITRI

Yukihiro Takatani – Hitachi

Seishi Hanaoka – Hitachi

Kenji Saito – KDDI

Toshiuki Kuze – Mitsubishi

Mitsuo Nohara – KDDI

Yong Sun – Toshiba

Changhoi Koo – STA

HyoungKyu Lim – Samsung

Moo Ryong Jeong – DoCoMo

Guoquiang Wang – Nortel

Kaixin Xu

Hua-Chiang Yin – Ill

Yousef Saifullah – Nokia

HyunJeong Kang – Samsung

John Lee – Huawei

David Comstock – Huawei

Hyan Lee – ETRI

Sungcheol Chang – ETRI

Kungkyung Kim – ETRI

Sook-Jin Lee – ETRI

Willem Mulder – Minnova

Arving Raghavan – Arraycomm

Jen-Shun Tang – ITRI

WernHo Sheen – ITRI

Takeo Kanai – Softbank SB

Deepesh Manshrestha – Ajou University

Hongyun Qu – ZTE

Chung GT. Kang – Korea University

Shashikant Maheshwari – Nokia

Scott Migaldi – Motorola

Peng-Yong Kong – I2R

Yongseok Park – Samsung

DaeYoung Jang – SKTelecom

Hyangjin Choi – TTA

YongSeok Choi - ETRI

Ad Hoc Participants (2)

Kanchei Loa – III
Yung-Ting Lee – III
Youn-Tai Lee – III
Hyunjeong Lee – Intel
Tzu-Ming Lin – ITRI
Torsen Fahldieck – Alcatel
Matty Levanda – WiNetworks
Junbae Ahn – Solid Technologies
Shan Shan Xu – Intel
Kyung Soo Kim – ETRI
Yanghwan Jin – Chungman National University
Geng Wu – Nortel
Tan Pek Yun – Panasonic
David Maidment – PicoChip
Christian Lambidi – IDT
Dharma Basgeet – Toshiba
Carl Posthuma – Lucent
Sumeet Sandhu – Intel
Hyung-kee Kim – Samsung Thales
Kyuha Lee – Samsung Thales
Ranga Reddy – US Army
Yuanyuan Wang – Huawei
Gang Shen - Alcatel
Dae-Joong Kim - Posdata

Havish Koorapaty - Ericson
Mike Hart – Fujitsu
Naftali Chayat – Alvarion
Peiying Zhu – Nortel
Mohan Fong – Nortel
Jun Li – Nortel
Yukimasa Nagai – Mitsubishi
Tetsu Ikeda - Motorola
Anthony Reid – Nokia
Adrian Boariu - Nokia

Process

- Use 050r2 as starting point as directed by TG chair
- Go contribution by contribution and consider modifications/additions to 050 to harmonize

Contributions

- 050r2
- 048
- 061
- 054
- 056
- 047
- 072
- 049
- 046
- 051
- 053

Main Points of Discussion

- **Frame Structure Requirement**
 - Discussion on whether there must be one frame structure for both relay and access links
 - Group agreed to word the requirement to allow technical proposals to determine whether there is a single frame structure or more than one frame structure
- **Document Status**
 - Group discussed whether TR document is a binding document or a guideline
 - TG chair clarified that document is a guideline
- **Mandatory/Optional Designations**
 - Mandatory/optional designations specified in the document are guidelines
 - They are current best guess of the group
 - They will be refined as technical proposals come are considered

Ad Hoc Results and Recommendation

- Ad Hoc completed harmonization of contributions based on C80216j-06_050r2
 - Harmonized document is C80216j-06_050r3
- Ad Hoc recommendation is for TG to accept C80216j-06_050r3 as the baseline technical requirements document